

# Phase Control Thyristors (Hockey PUK Version), 350 A



TO-200AB (A-PUK)

PRODUCT SUMMARY						
Package	TO-200AB (A-PUK)					
Diode variation	Single SCR					
I <sub>T(AV)</sub>	350 A					
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V to 2000 V					
$V_{TM}$	1.96 V					
I <sub>GT</sub>	150 mA					
$T_J$	-40 °C to 125 °C					

#### **FEATURES**

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- RoHS
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		350	А		
I <sub>T(AV)</sub>	T <sub>hs</sub>	55	°C		
1		660	A		
I <sub>T(RMS)</sub>	T <sub>hs</sub>	25	°C		
	50 Hz	5000	^		
I <sub>TSM</sub>	60 Hz	5230	— A		
124	50 Hz	125	kA <sup>2</sup> s		
l <sup>2</sup> t	60 Hz	114			
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 2000	V		
tq	Typical	100	μs		
T <sub>J</sub>		-40 to 125	°C		

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS								
TYPE NUMBER	R VOLTAGE CODE VDRM/VRRM, MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE VON-R		VOLTAGE NON-REPETITIVE		V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM mA		
	04	400	500					
	08	800	900					
VS-ST180CC	12	1200	1300	30				
V3-31160CC	16	1600	1700	30				
	18	1800	1900					
	20	2000	2100					



ABSOLUTE MAXIMUM RATINGS	S					
PARAMETER	SYMBOL		VALUES	UNITS		
Maximum average on-state current	I	180° condu	180° conduction, half sine wave			Α
at heatsink temperature	I <sub>T(AV)</sub>	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 25 °C	heatsink temp	erature double side cooled	660	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle	ı	t = 8.3 ms	reapplied		5230	A kA <sup>2</sup> s
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>	Sinusoidal half wave, initial $T_J = T_J$ maximum	4200	
		t = 8.3 ms	reapplied		4400	
	l <sup>2</sup> t	t = 10 ms	No voltage		125	
Marriage and 124 for fraing		t = 8.3 ms	reapplied		114	
Maximum I <sup>2</sup> t for fusing		t = 10 ms	100 % V <sub>RRM</sub>		88	
		t = 8.3 ms	reapplied		81	
Maximum $I^2\sqrt{t}$ for fusing	I <sup>2</sup> √t	t = 0.1 to 10	ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x \mid_{T(AV)} < I < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	1.08	V
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			V
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x π	$(16.7 \% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			mΩ
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			1.14	11122
Maximum on-state voltage	$V_{TM}$	$I_{pk} = 750 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			1.96	V
Maximum holding current	I <sub>H</sub>	T 05:00 1 1 10 1/2 1/2 1/2 1/2 1/2 1/2 1/2 1/2 1/2 1/2		600	A	
Maximum (typical) latching current	IL	T <sub>J</sub> = 25 °C, anode supply 12 V resistive load			1000 (300)	mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega$ , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/μs
Typical delay time	t <sub>d</sub>	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}$ , $T_J = 25 °C$	1.0	5
Typical turn-off time	t <sub>q</sub>	$\begin{aligned} I_{TM} &= 300 \text{ A, } T_J = T_J \text{ maximum, dI/dt} = 20 \text{ A/}\mu\text{s,} \\ V_R &= 50 \text{ V, dV/dt} = 20 \text{ V/}\mu\text{s, gate 0 V 100 }\Omega, t_p = 500 \mu\text{s} \end{aligned}$	100	μs

BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT S		
Maximum critical rate of rise of off-state voltage	dV/dt	T <sub>J</sub> = T <sub>J</sub> maximum linear to 80 % rated V <sub>DRM</sub>	500	V/µs		
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	30	mA		



TRIGGERING								
PARAMETER	SYMBOL	-	TEST CONDITIONS			UNIT		
PANAMETEN	STWIBOL	'	EST CONDITIONS	typ.	max.	S		
Maximum peak gate power	P <sub>GM</sub>	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	10		W		
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV		
Maximum peak positive gate current	I <sub>GM</sub>			3	.0	Α		
Maximum peak positive gate voltage	+ V <sub>GM</sub>	$T_J = T_J$ maximum, $t_p \le 5$ ms			$T_J = T_J$ maximum, $t_p \le 5$ ms		.0	V
Maximum peak negative gate voltage	- V <sub>GM</sub>				.0	v		
	I <sub>GT</sub>	T <sub>J</sub> = - 40 °C		180	-			
DC gate current required to trigger		T <sub>J</sub> = 25 °C		90	150	mA		
		T <sub>J</sub> = 125 °C	Maximum required gate trigger/ current/voltage are the lowest value	40	-			
		T <sub>J</sub> = - 40 °C	which will trigger all units 12 V		-			
DC gate voltage required to trigger	$V_{GT}$	T <sub>J</sub> = 25 °C	anode to cathode applied	1.8	3.0	٧		
		T <sub>J</sub> = 125 °C		1.2	-			
DC gate current not to trigger	I <sub>GD</sub>	T. T. magazina	Maximum gate current/voltage not to trigger is the maximum value	10		mA		
DC gate voltage not to trigger	V <sub>GD</sub>	$T_J = T_J \text{ maximum}$	which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode applied	0.25		V		

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT S		
Maximum operating junction temperature range	T <sub>J</sub>		-40 to 125	°C		
Maximum storage temperature range	T <sub>Stg</sub>		-40 to 150			
Maximum thermal resistance, junction to heatsink	R <sub>thJ-hs</sub>	DC operation single side cooled	0.17			
		DC operation double side cooled	0.08	K/W		
Maximum thermal resistance,	R <sub>thC-hs</sub>	DC operation single side cooled	0.033	N/VV		
case to heatsink		DC operation double side cooled	0.017			
Mounting force, ± 10 %			4900 (500)	N (kg)		
Approximate weight			50	g		
Case style		See dimensions - link at the end of datasheet	TO-200AB (A	A-PUK)		



△R <sub>thJC</sub> CONDUCTION								
CONDUCTION ANGLE		OIDAL JCTION			TEST CONDITIONS	UNITS		
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE				
180°	0.015	0.015	0.011	0.011				
120°	0.018	0.019	0.019	0.019	$T_J = T_J$ maximum			
90°	0.024	0.024	0.026	0.026		K/W		
60°	0.035	0.035	0.036	0.037				
30°	0.060	0.060	0.060	0.061				

#### Note

The table above shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC

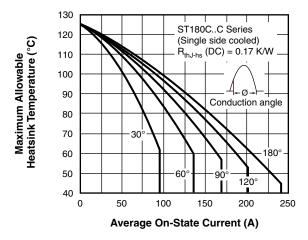


Fig. 1 - Current Ratings Characteristics

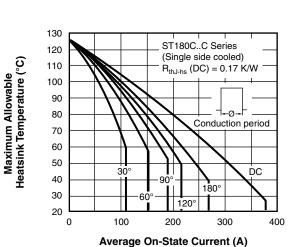


Fig. 2 - Current Ratings Characteristics

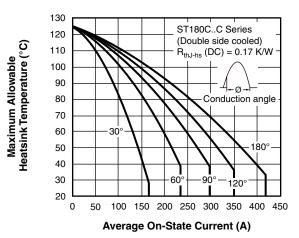


Fig. 3 - Current Ratings Characteristics

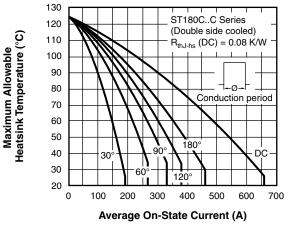


Fig. 4 - Current Ratings Characteristics

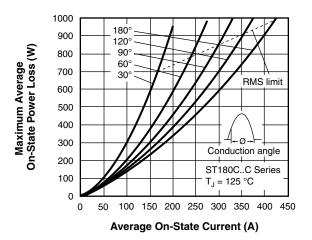


Fig. 5 - On-State Power Loss Characteristics

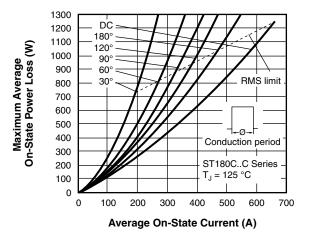
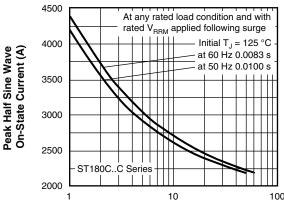


Fig. 6 - On-State Power Loss Characteristics



Number of Equal Amplitude Half Cycle Current Pulses (N)

Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

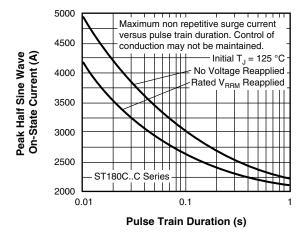


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

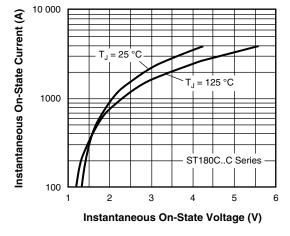


Fig. 9 - On-State Voltage Drop Characteristics

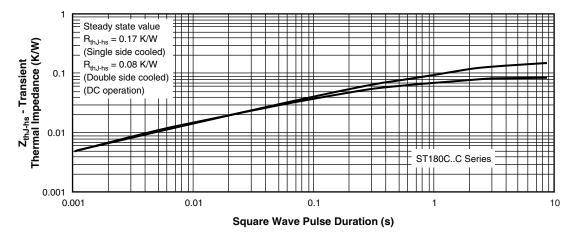


Fig. 10 - Thermal Impedance Z<sub>thJ-hs</sub> Characteristics

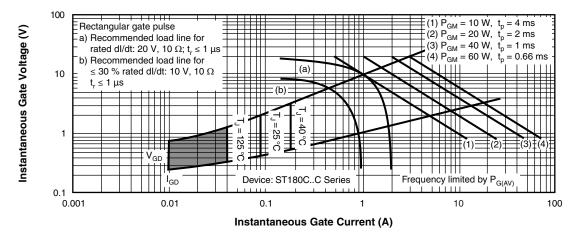
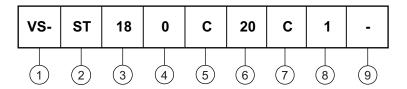


Fig. 11 - Gate Characteristics



#### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Thyristor

Essential part number

0 = Converter grade

5 - C = Ceramic PUK

6 - Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table)

7 - C = PUK case TO-200AB (A-PUK)

- 0 = Eyelet terminals (gate and auxiliary cathode unsoldered leads)

1 = Fast-on terminals (gate and auxiliary cathode unsoldered leads)

2 = Eyelet terminals (gate and auxiliary cathode soldered leads)

3 = Fast-on terminals (gate and auxiliary cathode soldered leads)

9 - Critical dV/dt: • None = 500 V/µs (standard selection)

• L = 1000 V/µs (special selection)

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95074			

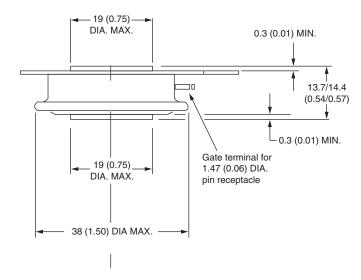


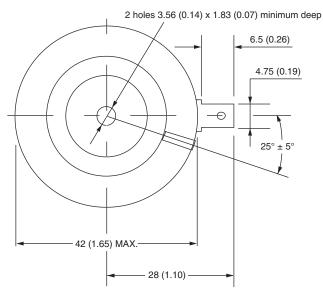
# **TO-200AB (A-PUK)**

#### **DIMENSIONS** in millimeters (inches)

Anode to gate

Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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